

L Number	Hits	Search Text	DB	Time stamp
1	42	(ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet))).clm. and (bonding with temperature).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 12:18
-	791	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method and piezoelectric).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/12 18:59
-	12418	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:21
-	22407	(ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet))).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:37
-	123	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method and piezoelectric and etch\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/12 19:01
-	13	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method and piezoelectric and etch\$3 and temperature).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/12 19:00
-	92	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method and piezoelectric and adhesive).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/12 19:01
-	807	((ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet)))) and method and etch\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:18
-	455	(216/27).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:18
-	197	(438/21).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:18
-	705	(29/890.1).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:18
-	422	((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and etch\$3).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:22
-	43	((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and etch\$3 and piezoelectric).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	776	(347/20).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:19

-	831	(347/40).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:19
-	520	(347/44).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:19
-	1347	(347/47).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:19
-	805	(347/54).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:19
-	525	(347/63).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	1636	(347/68).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	165	(347/69).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	537	(347/70).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	575	(347/71).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	192	(347/72).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:20
-	105	(( (347/20).CCLS.) or ((347/40).CCLS.) or ((347/44).CCLS.) or ((347/47).CCLS.) or ((347/54).CCLS.) or ((347/63).CCLS.) or ((347/68).CCLS.) or ((347/69).CCLS.) or ((347/70).CCLS.) or ((347/71).CCLS.) or ((347/72).CCLS.)) and (method and etch\$3 and piezoelectric).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:22
-	487	(( (347/20).CCLS.) or ((347/40).CCLS.) or ((347/44).CCLS.) or ((347/47).CCLS.) or ((347/54).CCLS.) or ((347/63).CCLS.) or ((347/68).CCLS.) or ((347/69).CCLS.) or ((347/70).CCLS.) or ((347/71).CCLS.) or ((347/72).CCLS.)) and (method and piezoelectric).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:24

-	410	((((347/20).CCLS.) or ((347/40).CCLS.) or ((347/44).CCLS.) or ((347/47).CCLS.) or ((347/54).CCLS.) or ((347/63).CCLS.) or ((347/68).CCLS.) or ((347/69).CCLS.) or ((347/70).CCLS.) or ((347/71).CCLS.) or ((347/72).CCLS.)) and (method and piezoelectric).clm.) not (((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and piezoelectric).clm.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:24
-	132	((((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and piezoelectric).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:23
-	81	((((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and piezoelectric).clm. and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:34
-	258	((((347/20).CCLS.) or ((347/40).CCLS.) or ((347/44).CCLS.) or ((347/47).CCLS.) or ((347/54).CCLS.) or ((347/63).CCLS.) or ((347/68).CCLS.) or ((347/69).CCLS.) or ((347/70).CCLS.) or ((347/71).CCLS.) or ((347/72).CCLS.)) and (method and piezoelectric).clm. and etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:24
-	215	((((347/20).CCLS.) or ((347/40).CCLS.) or ((347/44).CCLS.) or ((347/47).CCLS.) or ((347/54).CCLS.) or ((347/63).CCLS.) or ((347/68).CCLS.) or ((347/69).CCLS.) or ((347/70).CCLS.) or ((347/71).CCLS.) or ((347/72).CCLS.)) and (method and piezoelectric).clm. and etch\$3) not (((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and piezoelectric).clm. and etch\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/13 18:24
-	1	((((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (method and piezoelectric and (thermal\$3 adj (bond\$3 or adher\$3))).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:35
-	3	((((216/27).CCLS.) or ((438/21).CCLS.) or ((29/890.1).CCLS.)) and (thermal\$3 adj (bond\$3 or adher\$3))).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 09:36
-	13	(ink\$1jet or inkjet or (ink adj jet) or printhead or (liquid adj (ejecting or recording or jet))).clm. and (thermal\$3 adj (adher\$3 or bond\$3)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/18 12:18